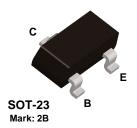


Discrete POWER & Signal **Technologies**

PN2907

MMBT2907





PNP General Purpose Amplifier

This device is designed for use as general purpose amplifiers and switches requiring collector currents to 500 mA. Sourced from Process 63. See PN2907A for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	60	V
V_{EBO}	Emitter-Base Voltage	5.0	V
I _C	Collector Current - Continuous	800	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range -55 to +150 °C		°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max Units		Units
		PN2907	*MMBT2907	
P _D	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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PNP General Purpose Amplifier (continued)

Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = 10 \text{ mA}, I_B = 0$	40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	60		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	5.0		V
I _{CEX}	Collector Cutoff Current	V _{CE} = 30 V		50	nA
I _B	Base Cutoff Current	V _{BE} = 0.5 V		50	nA
Ісво	Collector Cutoff Current	V _{CB} = 50 V, I _E = 0 V _{CB} = 50 V, I _E = 0, T _A = 150 °C		20 20	nA μA
ON CHAF	RACTERISTICS*				
h_{FE}	DC Current Gain	$V_{CE} = 10 \text{ V}, I_{C} = 0.1 \text{ mA}$	35		
		$V_{CE} = 10 \text{ V}, I_{C} = 1.0 \text{ mA}$	50		
		$V_{CE} = 10 \text{ V}, I_{C} = 10 \text{ mA}$	75	200	
		$V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$ $V_{CE} = 10 \text{ V}, I_C = 500 \text{ mA}$	100 30	300	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	30	0.4	V
- OL(Sat)		$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		1.6	V
$V_{\text{BE(sat)}}$	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$		1.3	V
		$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		2.6	V
SMALL S	IGNAL CHARACTERISTICS				
C _{ob}	Output Capacitance	$V_{CB} = 10 \text{ V}, f = 1.0 \text{ MHz}$		8.0	pF
C_{ib}	Input Capacitance	$V_{EB} = 2.0 \text{ V, f} = 1.0 \text{ MHz}$		30	pF
h _{fe}	Small-Signal Current Gain	$I_C = 50 \text{ mA}, V_{CE} = 20 \text{ V},$ f = 100 MHz	2.0		
SWITCHI	NG CHARACTERISTICS				
t _{on}	Turn-on Time	$V_{CC} = 30 \text{ V}, I_{C} = 150 \text{ mA},$		45	ns
t _d	Delay Time	I _{B1} = 15 mA , PW = 200 ns		10	ns
t _r	Rise Time	1		40	ns
t _{off}	Turn-off Time	$V_{CC} = 6.0 \text{ V}, I_{C} = 150 \text{ mA}$		100	ns
VOII		1			<u> </u>
t _s	Storage Time	$I_{B1} = I_{B2} = 15 \text{ mA}$		80	ns

^{*}Pulse Test: Pulse Width $\leq 300~\mu\text{s},~\text{Duty Cycle} \leq 2.0\%$

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